

# Xinger, III

# The X3C35F1-(coupler in a ne package. The power and low

Hybrid Coupler 2 dB. 90°

The X3C35F1-02S is a low profile, high performance 3dB hybrid coupler in a new easy to use, manufacturing friendly surface mount package. The X3C35F1-02S is designed particularly for balanced power and low noise amplifiers, plus signal distribution and other applications where low insertion loss and tight amplitude and phase balance is required. It can be used in high power applications up to 15 watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4003 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion finish

#### **Detailed Electrical Specifications:**

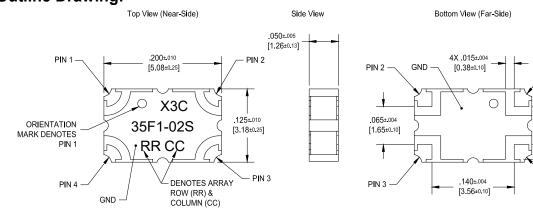
#### Features:

- 3300-3800 MHz
- Doherty Amplifier
- High Power
- Very Low Loss
- Tight Amplitude Balance
- High Isolation
- Production Friendly
- Tape and Reel
- Lead-Free

Frequency	Directivity	Insertion Loss	VSWR	Coupling
MHz	dB Min	dB Max	Max : 1	dB
3300-3800	21	0.20	1.15	1.9 ± 0.15
3300-4200	16	0.35	1.25	2.0±0.20
	Phase	Group Delay	Power	Operating Temp.
	Degrees	ns	Avg. CW Watts at 95° C	°C
	90 ± 4.0	0.10 ± 0.01	15	-55 to +140
	90 ± 5.0	0.10 ± 0.03	10	-55 to +140

<sup>\*\*</sup>Specification based on performance of unit properly installed on TTM Technologies Test Board with small signal applied. Specifications subject to change without notice. Refer to parameter definitions for details.

#### **Outline Drawing:**



Dimensions are in Inches [Millimeters] X3C35F1-02S Mechanical Outline Tolerances are Non-Cumulative

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4X .015±.004

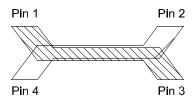
4X .025±.004 SQ

[0.64±0.10]



#### **Hybrid Coupler Pin Configuration**

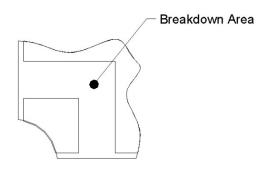
The X3C35F1-02S has an orientation marker to denote Pin 1. Once port one has been identified the other ports are known automatically. Please see the chart below for clarification:



Configuration	Pin 1	Pin 2	Pin 3	Pin 4
Splitter	Input	Isolated	-5dB < ⊖ -90	-2dB < ⊖
Splitter	Isolated	Input	-2dB < Θ	-5dB < Θ -90
Splitter	-5dB < ⊖ -90	-2dB < Θ	Input	Isolated
Splitter	-2dB < Θ	-5dB < ⊖ -90	Isolated	Input

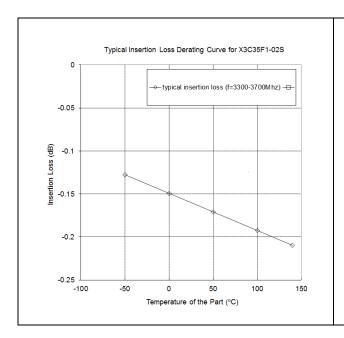
#### **Peak Power Handling**

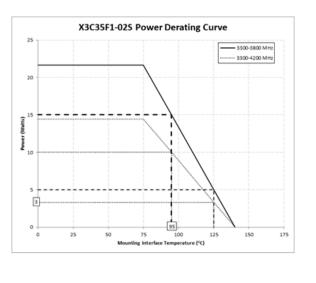
High-Pot testing of these couplers during the qualification procedure resulted in a minimum breakdown voltage of 1.25Kv (minimum recorded value). This voltage level corresponds to a breakdown resistance capable of handling at least 12dB peaks over average power levels, for very short durations. The breakdown location consistently occurred across the air interface at the coupler contact pads (see illustration below). The breakdown levels at these points will be affected by any contamination in the gap area around these pads. These areas must be kept clean for optimum performance. It is recommended that the user test for voltage breakdown under the maximum operating conditions and over worst case modulation induced power peaking. This evaluation should also include extreme environmental conditions (such as high humidity).





#### **Insertion Loss and Power Derating Curves**





#### **Insertion Loss Derating:**

The insertion loss, at a given frequency, of a group of couplers is measured at 25°C and then averaged. The measurements are performed under small signal conditions (i.e. using a Vector Network Analyzer). The process is repeated at 95°C and 140°C. A best-fit line for the measured data is computed and then plotted from -55°C to 140°C.

### **Power Derating:**

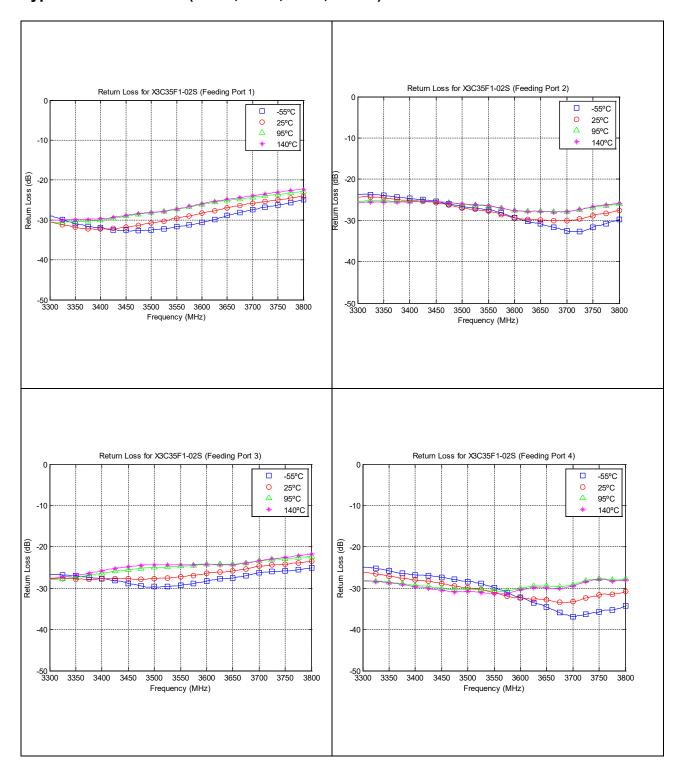
The power handling and corresponding power derating plots are a function of the thermal resistance, mounting surface temperature (base plate temperature), maximum continuous operating temperature of the coupler, and the thermal insertion loss. The thermal insertion loss is defined in the Power Handling section of the data sheet.

As the mounting interface temperature approaches the maximum continuous operating temperature, the power handling decreases to zero.

If mounting temperature is greater than 95°C, Xinger coupler will perform reliably as long as the input power is derated to the curve above.

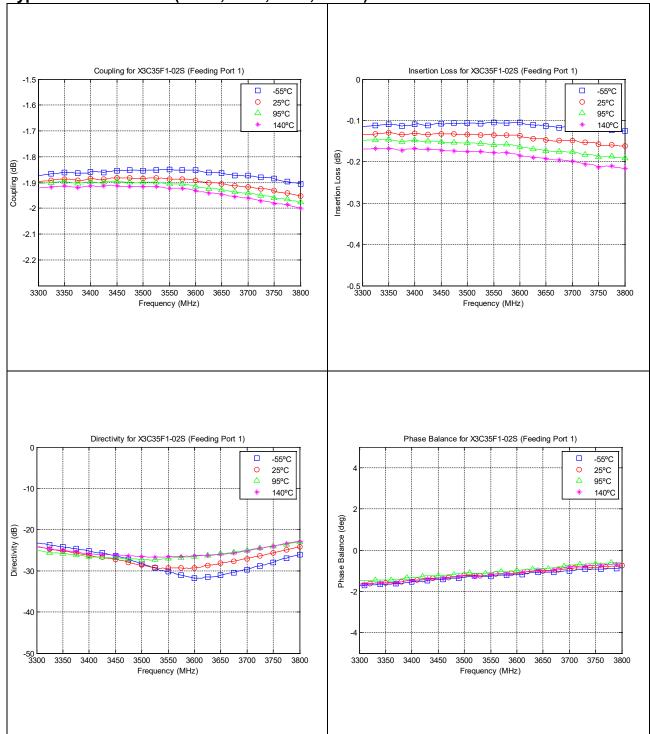


## Typical Performance: (-55°C, 25°C, 95°C, 140°C)





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# **Definition of Measured Specifications**

Parameter	Definition	Mathematical Representation
VSWR (Voltage Standing Wave Ratio)	The impedance match of the coupler to a $50\Omega$ system. A VSWR of 1:1 is optimal.	$VSWR = \frac{V_{max}}{V_{min}}$ $Vmax = voltage \ maxima \ of \ a \ standing \ wave$ $Vmin = voltage \ minima \ of \ a \ standing \ wave$
Return Loss	The impedance match of the coupler to a $50\Omega$ system. Return Loss is an alternate means to express VSWR.	Return Loss(dB) = $20\log \frac{VSWR+1}{VSWR-1}$
Insertion Loss	The input power divided by the sum of the power at the two output ports.	Insertion Loss(dB) = $10\log \frac{P_{in}}{P_{cpl} + P_{direct}}$
Directivity	The power at the coupled port divided by the power at the isolated port.	$10\log \frac{P_{\rm cpl}}{P_{\rm iso}}$
Phase Balance	The difference in phase angle between the two output ports.	Phase at coupled port – Phase at direct port
Mean Coupling	At a given frequency (on), coupling is the input power divided by the power at the coupled port. Mean coupling is the average value of the coupling values in the band. N is the number of frequencies in the band.	Coupling(dB) = $C(\omega_n) = 10log \frac{P_{in}(\omega_n)}{P_{cpl}(\omega_n)}$ Mean Coupling(dB) = $\frac{\sum_{n=1}^{N} C(\omega_n)}{N}$
Group Delay	Group delay is average of group delay's from input port to the coupled port	Average ( GD-C)